Appendix G

Solar Orbiter SPICE Thermal Design, Analysis and Testing

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Abstract

¹ The Spectral Imaging of the Coronal Environment (SPICE) is one of ten instruments comprising the ESA Solar Orbiter payload. The instrument, currently being built at the STFC Rutherford Appleton Laboratory, is a high resolution imaging spectrometer operating at extreme ultraviolet wavelengths. We are currently in the build phase, with thermal testing of the flight model instrument due to commence shortly.

At an orbital perihelion of just 0.28 AU, there are numerous key design challenges that must be overcome for the instrument to survive the harsh thermal environment that it will be subjected to. In the last 18 months, the instrument has already undergone considerable thermal testing to qualify the design. The results of the tests completed thus far have provided essential inputs into the existing detailed thermal model, which is constructed using ESATAN-TMS. This presentation will discuss how the thermal analysis and testing have complemented each other for this project, while also providing impressions of ESATAN-TMS from the perspective of a relatively early user.

¹Due to severe weather conditions the author was unable to attend the workshop and present this material.





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SPICE – Thermal Design

- Solar load is roughly 13 times greater than on Earth orbit
- Spacecraft heatshield blocks most incoming radiation
- Primary mirror has a 10 nm boron carbide (B₄C) coating
 - Reflective to UV radiation, but mostly transparent to visible and IR
- Secondary mirror (HRM) rejects this unnecessary load to deep space
- Only a small fraction of reflected UV load required, so pre-slit mirrors and heat dump radiator used to further reject heat
- Cold element interface maintains detectors at -20 °C















SPICE – Test Rig

- Specialised test rig built for thermal testing of SPICE, to simulate spacecraft cavity
- Fluid pipes around shroud allow interface temperatures to be simulated
- Heaters simulate heat flows from instrument to spacecraft
- Shroud is wrapped in multi-layer insulation (MLI) to minimise heat flow from vacuum chamber
- Test rig successfully completed commissioning tests prior to instrument testing















